AMPLIMITE

TE Internal #: 166293-1

Pin Contact, Gold, Snap-In Contact Retention, Size 20 Contact Size, 24 – 20 AWG Wire Size, .2 – .56 mm² Wire Size, Crimp, Brass, Signal

View on TE.com >



Connectors > Contacts > Connector Contacts > D-Sub Connector Contacts: Pin, Brass, Signal, Size 20











Contact Type: Pin

Contact Mating Area Plating Material: Gold

Contact Retention Type Within Housing: Snap-In

Contact Size: Size 20
Wire Size: 24 – 20 AWG

All D-Sub Connector Contacts: Pin, Brass, Signal, Size 20 (49)

Features

Contact Features

Mating Pin Diameter	1 mm
Contact Mating Area Plating Material Thickness	.76 µm
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Type	Pin
Contact Mating Area Plating Material	Gold
Contact Size	Size 20
Contact Base Material	Brass
Contact Current Rating (Max)	2 A

Termination Features

Termination Method to Wire & Cable	Crimp
Product Terminates To	Wire & Cable

Mechanical Attachment



Wire Insulation Support	With
Contact Retention Type Within Housing	Snap-In
Dimensions	
Compatible Insulation Diameter Range	1.27 – 1.52 mm[.05 – .06 in]
Wire Size	$.256 \text{ mm}^2$
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Identification Marking	
Contact Color Code	Red
Packaging Features	
Packaging Quantity	1000
Packaging Method	Loose Piece

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits



as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







Customers Also Bought

















TE Part #9-1768032-4 LEB-0415P-9

Documents

Product Drawings

LP HD20 COSI PIN CONTACT DF; 24-20 AWG

English



CAD Files

Customer View Model

ENG_CVM_CVM_166293-1_AB.2d_dxf.zip

English

3D PDF

3D

Customer View Model

ENG_CVM_CVM_166293-1_AB.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_166293-1_AB.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

Datasheets & Catalog Pages

AMPLIMITE Subminiature D Connectors - Subminiature D Connectors for Cable Mounting

English

NECTOR_S_LINE_CONNECTOR_BROCHURE

English

Product Specifications

Application Specification

English